# **Automated Programming** System



## **I/O Devices**



Auto tray - 535M

Tape-out - 512M

## Optional





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AT3-310A4
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AT3-310D2



Best option for mass and ramp-up demand

• Up to **2200** UPH with **2** pick & place nozzles

• 16-32 devices can be programmed simultaneously

Bestseller to provide comprehensive and reliable production experience

Best option for high-mix, low-volume production

Customized specification and configuration of system

to deliver the best production scale cost-effectively

• Equipped with **2** units of ALL-200G or ALL-300G2 programmers

- High quality and efficiency makes it the best programming option in such industries as consumer electronics, IoT etc.
  - Up to 3000 UPH with 4 pick & place nozzles
- Equipped with **4** units of ALL-200G or ALL-300G2 programmers
- 32-64 devices can be programmed simultaneously

10



#### HI-LO SYSTEMS

Optimal amount of programming site for high density IC programing such as UFS and eMMC

The best option for high-end IC production in such industries as automotive or military

Equipped with laser marker and optional 3D inspection makes it a perfect total-solution

• Over 2500 UPH with 4 pick & place nozzles

• Equipped with 6-8 units of ALL-200G or ALL-300G2 programmers

• **48-128** devices can be programmed simultaneously





Tape-in

Tube-in/Tube-out



### **Feature**

#### **Excellent performance**

- Minimize the jam rate as well as the possibility of lead bent during handling
- Capable of handling as small as 1.5mm x 1.5mm devices such as WLCSP

#### Support wide range of IC devices and packages

- Device supported: UFS, eMMC, eMCP, MCU/MPU, NOR/NAND Flash EEPROM, SPI Memory, FPGA, CPLD, etc.
- Package supported: DIP, SDIP, SOP, SSOP, TSOP, PLCC, QFP, QFN, SON, BGA, WLCSP, etc.

#### Precise vision positioning system

- Arm camera (1.3M pixels) for socket positioning
- Fixed camera (3M pixels) for IC pick & place positioning
- Optional AOI for 2D/3D inspection of IC appearance

#### **Smart operating software**

- All setup data such as IC type, socket type, and position are saved automatically to achieve zero changeover time
- User friendly operating interface minimize the possibility of misoperation
- Provides detailed information of machine status, production status, warning, etc. Detailed production reports and log files are saved for traceability

#### **Intelligent function setup**

- Laser displacement sensor: Automated height calibration of picking IC (Z-axis)
- Automated IC pick & place positioning reduces the changeover time to 15 minutes or less

#### **HILONET (MES)**

- **One-Click Start**-Operators can start production simply by scanning the barcode, significantly eliminating human errors
- **E-Board**-Visualize and update production statistics (Yield rate, UPH, the condition of sockets, etc.) promptly for management to track anytime
- Program Track System (PTS)-Completely record every order from end to end throughout the production process and provide valid statistics for management, realizing statistical process control (SPC)

#### Flexible I/O options

Support package conversion between tape, tray, and tube



## **Specification**

Throughput		Up to 2200 UPH	Up to 3000 UPH	Over 2500 UPH
Pick & Place System	Transmission	Precision ball screws and linear guides		
	Drive system	Servo motors		
	Resolution	X/Y/Ζ: 2.5 μm ፥ θ:0.15°		
Vision System	Arm camera	1.3M pixels, accuracy: ± 0.02 mm		
	Fixed camera	3M pixels, accuracy: ± 0.01 mm		
	Processing speed	0.03 s / device		
Programmer		ALL-200G x 2 units, up to 16 sockets ALL-300G2 x 2 units, up to 32 sockets	ALL-200G x 4 units, up to 32 sockets ALL-300G2 x 4 units, up to 64 sockets	ALL-200G x 6-8 units, up to 64 sockets ALL-300G2 x 6-8 units up to 128 sockets
I/O Devices		Auto tray (up to 25 JEDEC trays)		
	Tray	Semi-Auto tray		
		Manual tray		
	Таре	<ul> <li>Electric tape-in, 8~32mm (2 tape-in can be installed)</li> <li>Tape-out, 8~44mm, heat-sealing or adhesive cover tape Ink marking (dot, alphanumeric character)</li> </ul>		
	Tube	<ul> <li>Auto Tube-in, up to 25 tubes</li> <li>Tube-in, (4/6/8 tubes)</li> <li>Tube-out (4/6/8 tubes)</li> </ul>		
	Other	<ul><li>NG box</li><li>Bowl feeder</li></ul>		
Control system	Operating system	Windows 7, 10		
	Control interface	Monitor / Keyboard / Mouse		
	Comm. interface	Ethernet / USB 3.0		
Power	AC power	220 ~ 240V single phase / 50 - 60 Hz / 2.5 kW (max capacity)		
Air pressure		0.6 MPa, 45 L/min.		
Weight		830 kg (Main unit)		
Dimension	Main unit	W1500 x D840 x H1510 (mm)		
	+ Auto tray (front)	W1500 x D1475 x H1678 (mm)		
	+ Auto tray (back)	W1500 x D1432 x H1678 (mm)		
	+ Tape-in / Tape-out (front)	W1500 x D1845 x H1678 (mm)		
	+ Tube-in / Tube-out (front)	W1500 x D1650 x H1678 (mm)		
	+ Tape-in / Tape-out (front) + Auto tray (back)	W1500 x D2437 x H1678 (mm)		







HI-LO SYSTEMS